

Customer No.: 31561
Application No.: 10/709,179
Docket No.: 10544-US-PA

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Examiner: HA, NATHAN W.

Group Art Unit: 2814

In re PATENT APPLICATION of

Applicants :	Chang et al.)	
)	
Serial No. :	10/709,179)	
)	<u>AMENDMENTS</u>
Filed :	April 19, 2004)	
)	
For :	STACK-TYPE MULTI-CHIP)	
	PACKAGE AND METHOD OF)	
	FABRICATING BUMPS ON)	
	THE BACKSIDE OF A CHIP)	
)	Attorney Docket: 10544-US-PA
)	_____

The Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-2620 (Order No.: 10544-US-PA)

AMENDMENTS AND RESPONSE TO OFFICE ACTION

United States Patent and Trademark Office
Customer Service Window
Mail Stop **AF**
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Dear Sir:

The Office Action dated June 06, 2008, has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.